Small Signal MOSFET

Single N-Channel, 60 V, 310 mA, 2.5 Ohm

Features

- Low R_{DS(on)}
- Small Footprint Surface Mount Package
- Trench Technology
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Low Side Load Switch
- Level Shift Circuits
- DC–DC Converter
- Portable Applications i.e. DSC, PDA, Cell Phone, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Rating		Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	60	V
Gate-to-Source Voltage		V _{GS}	±20	V
Drain Current (Note 1) Steady State t < 5 s	$T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$ $T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$	ID	260 190 310 220	mA
Power Dissipation (Note 1) Steady State t < 5 s		PD	300 420	mW
Pulsed Drain Current ($t_p = 10 \ \mu s$)		I _{DM}	1.2	А
Operating Junction and Storage Temperature Range		T _J , T _{STG}	–55 to +150	°C
Source Current (Body Diode)		IS	300	mA
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 1)	R_{\thetaJA}	417	°C/W
Junction–to–Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	300	

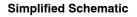
1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)

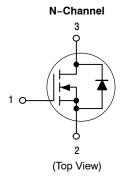


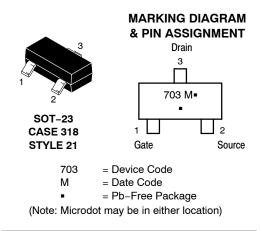
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX (Note 1)
60 V	3.0 Ω @ 4.5 V	310 mA
	2.5 Ω @ 10 V	







ORDERING INFORMATION

Device	Package	Shipping [†]
2N7002ET1G, S2N7002ET1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
2N7002ET7G, S2N7002ET7G	SOT-23 (Pb-Free)	3500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

2N7002E

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

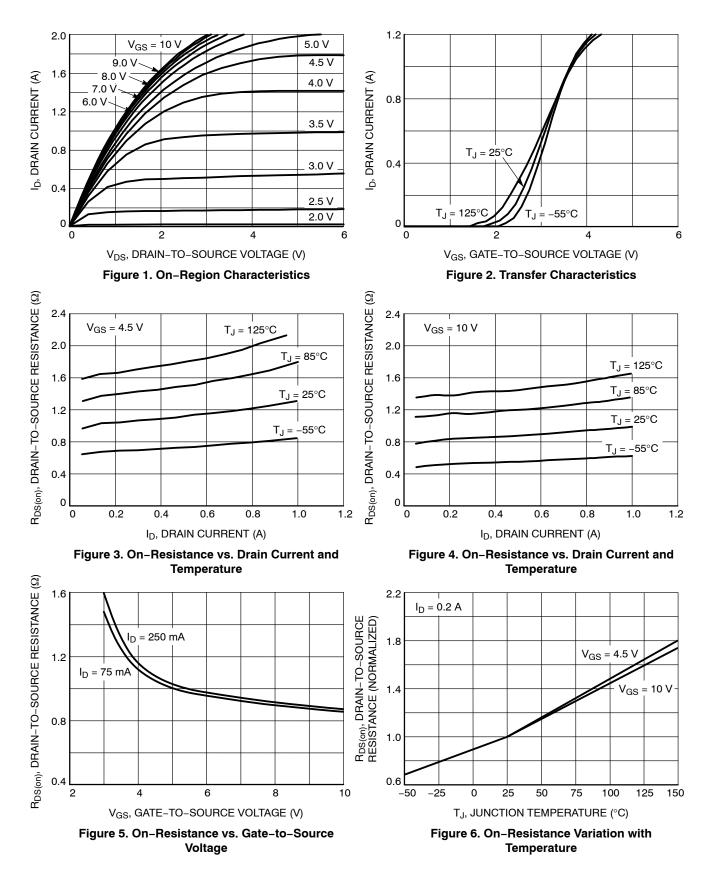
Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				75		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25°C T _J = 125°C			1 500	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V				±100	nA
ON CHARACTERISTICS (Note 2)		•					
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 240 mA			0.86	2.5	Ω
		V _{GS} = 4.5 V, I _D = 50 mA			1.1	3.0	
Forward Transconductance	9 FS	$V_{DS} = 5 V, I_{D} = 200 mA$			530		mS
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			26.7	40	pF
Output Capacitance	C _{OSS}				4.6		
Reverse Transfer Capacitance	C _{RSS}				2.9		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 5 \text{ V}, V_{DS} = 10 \text{ V};$ I _D = 240 mA			0.81		nC
Threshold Gate Charge	Q _{G(TH)}				0.31		-
Gate-to-Source Charge	Q _{GS}				0.48		
Gate-to-Drain Charge	Q _{GD}				0.08		
SWITCHING CHARACTERISTICS, V_{GS}	= V (Note 3)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DD} = 30 V, I _D = 200 mA, R _G = 10 Ω			1.7		ns
Rise Time	t _r				1.2		
Turn-Off Delay Time	t _{d(OFF)}				4.8		
Fall Time	t _f				3.6		
DRAIN-SOURCE DIODE CHARACTER	ISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.79	1.2	V
	1	I			1		1

 $I_{\rm S} = 200 \text{ mA}$ $T_J = 85^{\circ}C$ 0.7 Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2% 3. Switching characteristics are independent of operating junction temperatures

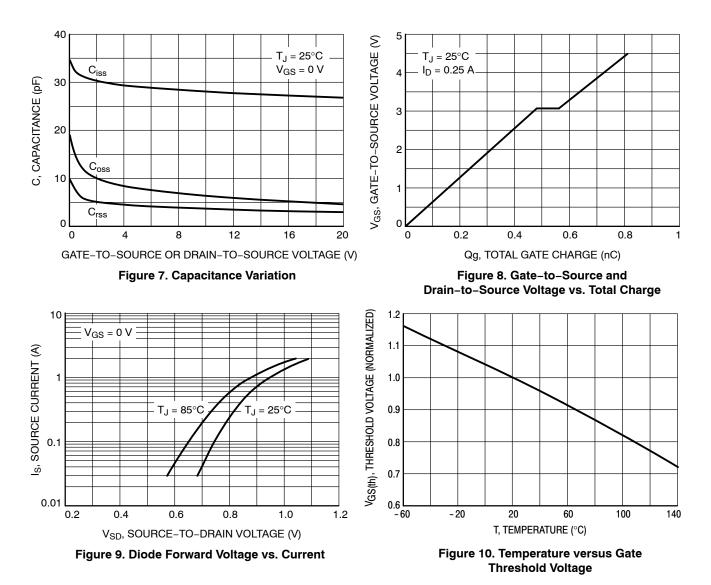
2N7002E

TYPICAL CHARACTERISTICS

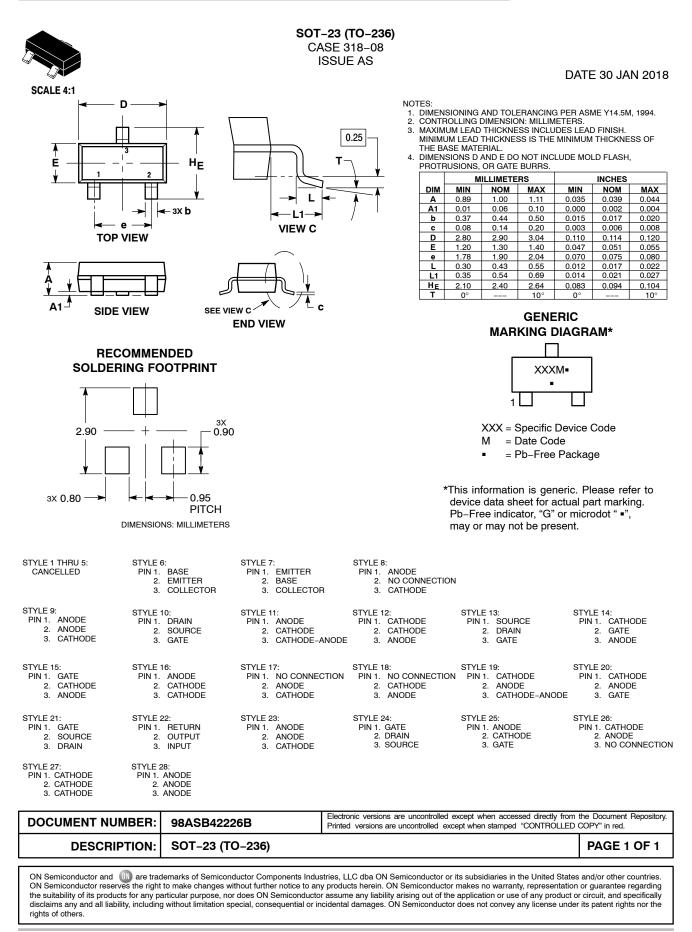


2N7002E

TYPICAL CHARACTERISTICS







onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters, including "Typicals" must be validated for each customer applications by customer's technical experts. onsemi does not cust performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application or autorized for use as a critical component in life support systems or any CDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any divide for indirectly, any claim of personal injury or death associated with such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and is officers, employees, subsidiaries, and expenses, and expenses, and exponses hard snegges that onsemi was negligent regarding the design or unauthorized use ever if such claim alleges that onsemi was negligent regarding the design or manufacture of the part. onsemi is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright have and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

 \Diamond